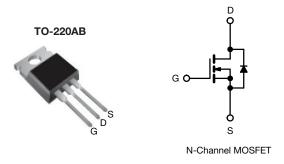
SiHP35N60E

Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.082		
Q _g max. (nC)	132			
Q _{gs} (nC)	22			
Q _{gd} (nC)	46			
Configuration	Single			

FEATURES

- A specific on resistance (m $\Omega\text{-}cm^2$) reduction of 25 %
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (C_{iss})
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_g)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Power factor correction power supplies (PFC)
- · Hard switching PWM stages
- Computing
 - Switch mode power supplies (SMPS)
- Lighting
 - Light emitting diode (LED)
 - High intensity discharge (HID)
- Telecom
 - Server power supplies
- Renewable energy
 - Photovoltaic inverters
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Uniterruptable power supplies

ORDERING INFORMATION			
Package	TO-220AB		
Load (Dh) free and helegen free	SiHP35N60E-BE3 ^a		
Lead (Pb)-free and halogen-free	SiHP35N60E-GE3		

Note

a. "-BE3" denotes alternate manufacturing location

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unle	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	600	Ň	
Gate-source voltage			V _{GS}	± 30	V	
Continuous drain surrent (T 150 °C)	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C	1	32	А	
Continuous drain current ($T_J = 150 \ ^\circ C$)	V _{GS} at 10 V	T _C = 100 °C	ID	20		
Pulsed drain current ^a			I _{DM}	80		
Linear derating factor				2	W/°C	
Single pulse avalanche energy b			E _{AS}	691	mJ	
Maximum power dissipation			PD	250	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope	T _J = 125 °C			57	Mar	
Reverse diode dV/dt d			dV/dt	31	V/ns	
Soldering recommendations (peak temperature) ^c	For	10 s		300	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 7 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, dl/dt = 100 A/µs, starting T_J = 25 °C

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PARAMETER	SYMBOL	TYP.	MAX	κ.	UNIT		
Maximum junction-to-ambient	R _{thJA}	- 62 - 0.5					
Maximum junction-to-case (drain)	R _{thJC}				°C/W		
SPECIFICATIONS ($T_J = 25 \text{ °C}$, ι	nless otherwi	ise noted)					
PARAMETER	SYMBOL		T CONDITIONS	MIN.	TYP.	MAX.	UNI
Static		4			<u> </u>		
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.70	-	V/°C
Gate-source threshold Voltage (N)	V _{GS(th)}		· V _{GS} , I _D = 250 μA	2	-	4	V
			$V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
Gate-source leakage	I _{GSS}		$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μA
			600 V, V _{GS} = 0 V	-	-	1	
aro date voltade drain current		, V _{GS} = 0 V, T _J = 125 °C	-	-	25	μA	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 17 A	-	0.082	0.094	Ω
Forward transconductance	g _{fs}		= 30 V, I _D = 17 A	-	13	-	S
Dynamic				I		1	
Input capacitance	C _{iss}	$V_{GS} = 0 V, V_{DS} = 100 V, f = 1 MHz$		-	2760	-	pF
Output capacitance	C _{oss}			-	118	-	
Reverse transfer capacitance	C _{rss}			-	5	-	
Effective output capacitance, energy related ^a	C _{o(er)}	- V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	118	-	
Effective output capacitance, time related ^b	C _{o(tr)}			-	429	-	
Total gate charge	Qg			-	88	132	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 17 \text{ A}, V_{DS} = 480 \text{ V}$		22	-	nC
Gate-drain charge	Q _{gd}			-	46	-	
Turn-on delay time	t _{d(on)}			-	29	58	
Rise time	t _r	V _{DD} =	= 480 V, I _D = 17 A,	-	61	92	1
Turn-off delay time	t _{d(off)}	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	78	117	- ns
Fall time	t _f			-	32	64	
Gate input resistance	Rg	f = 1 MHz, open drain		0.25	0.5	1	Ω
Drain-Source Body Diode Characteristic				•			
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	32	
Pulsed diode forward current	I _{SM}			-	-	80	A
Diode forward voltage	V _{SD}	T _J = 25 °C	C, I _S = 17 A, V _{GS} = 0 V	-	0.9	1.2	V
Reverse recovery time	t _{rr}	_		-	455	910	ns
Reverse recovery charge	Q _{rr}	$T_{J} = 25$	$5 ^{\circ}\text{C}, I_{\text{F}} = I_{\text{S}} = 17 \text{A},$ 100 A/us V= - 25 V	-	8	16	μC
Reverse recovery current	I _{RRM}	dl/dt = 100 A/µs, V _R = 25 V		-	30	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 % to 80 % VDSS



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

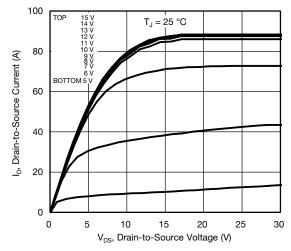
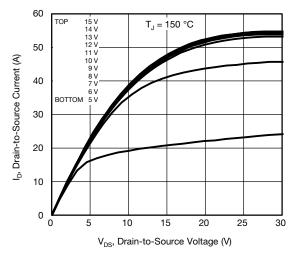


Fig. 1 - Typical Output Characteristics





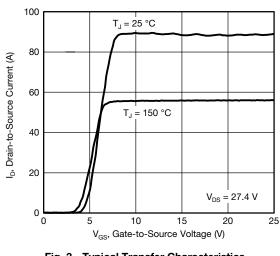


Fig. 3 - Typical Transfer Characteristics

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3.0 R_{DS(on)}, Drain-to-Source On-Resistance 2.5 2.0 (Normalized) 10 \ GŞ 1.0 0.5 40 - 20 0 20 40 60 80 100 120 140 160 T_., Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

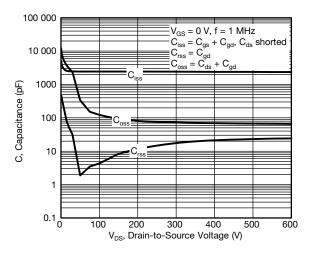
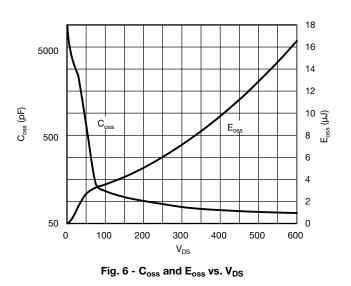


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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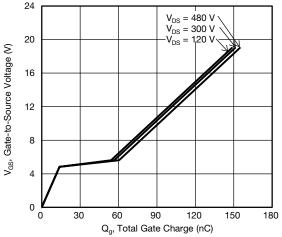


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

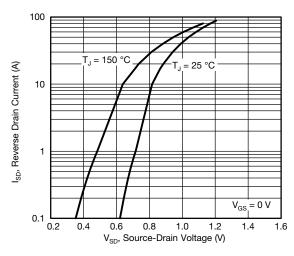
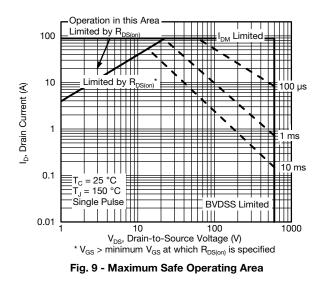


Fig. 8 - Typical Source-Drain Diode Forward Voltage



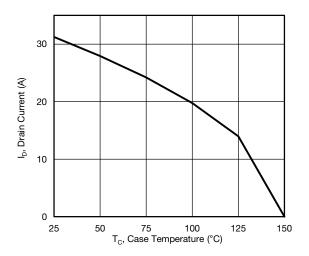


Fig. 10 - Maximum Drain Current vs. Case Temperature

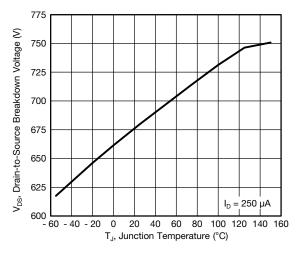


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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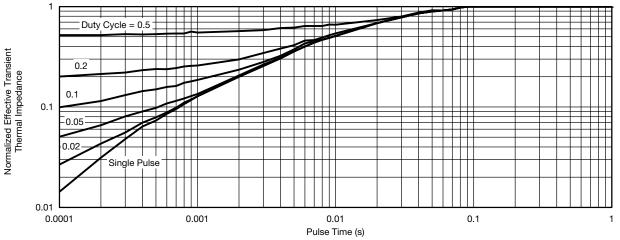
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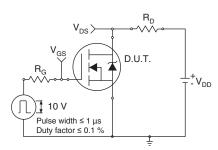


Fig. 13 - Switching Time Test Circuit

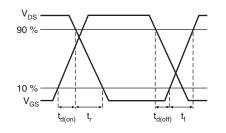


Fig. 14 - Switching Time Waveforms

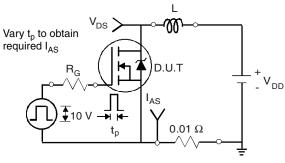


Fig. 15 - Unclamped Inductive Test Circuit

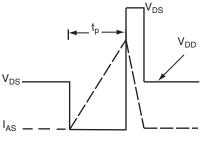


Fig. 16 - Unclamped Inductive Waveforms

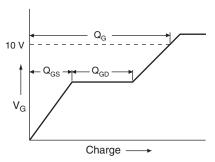
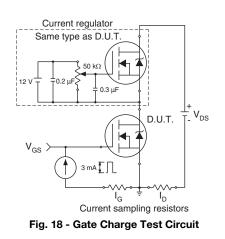


Fig. 17 - Basic Gate Charge Waveform



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Peak Diode Recovery dV/dt Test Circuit

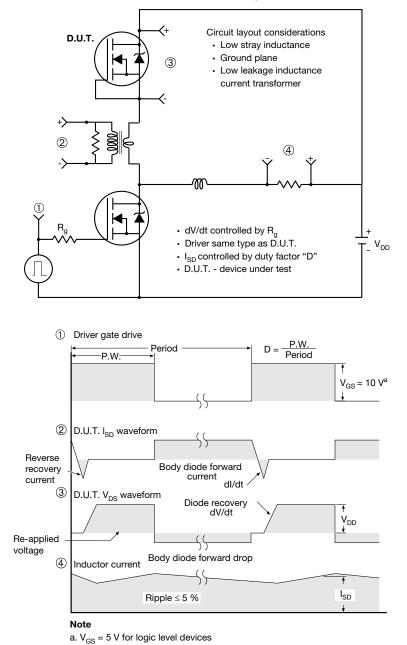


Fig. 19 - For N-Channel

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TO-220-1



DIM	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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